

# IEEE EPS as Moderator and Panelist in APSSE 2024

Oct 16-18<sup>th</sup>, 2024



- The 2024 Asia-Pacific Semiconductor Summit and Expo (APSSE) was organized by MSIA in Penang from October 16 to 18, 2024. The event has gathered industry leaders, featuring an exhibition, forum speeches, and business matching opportunities. The event aims to explore future development trends in the pan-semiconductor industry, along with fostering innovation and collaboration within the sector.
- IEEE EPS Chair, Dr Eu Poh Leng, and Past Chair Dr YY Tan were invited as moderator and panelist respectively, to expound on “Advanced Packaging – The Next Frontier in Semiconductor Packaging Exploring the Innovations Shaping Technologies”. The Panel Session was attended by about 100 participants.